



RF360  
Europe GmbH

## Data sheet

SAW filter  
GPS

Series/type:	B4300
Ordering code:	B39162B4300F210
Date:	July 12, 2019
Version:	2.3

DCN: 80-PA243-356 Rev. A

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A Qualcomm – TDK Joint Venture

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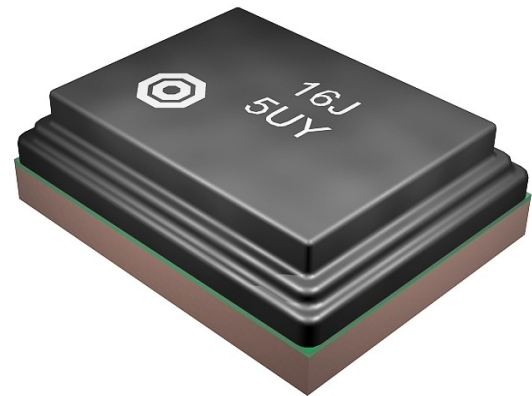
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## 1 Application

- Low-loss RF filter for GPS application
- No matching network required for operation at 50  $\Omega$

## 2 Features

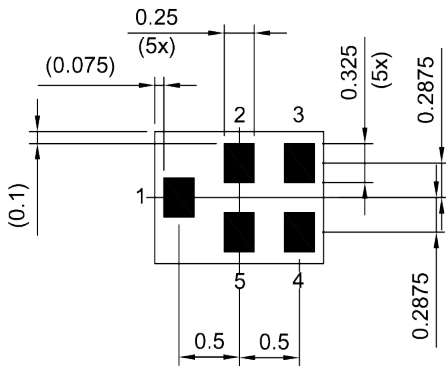
- Package size 1.4 $\pm$ 0.1 mm  $\times$  1.1 $\pm$ 0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to +85 °C)



**Figure 1:** Picture of component with example of product marking.

3 Package

BOTTOM VIEW

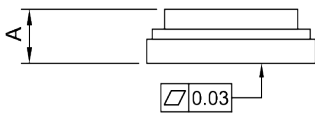


Pad and pitch tolerance ±0.05

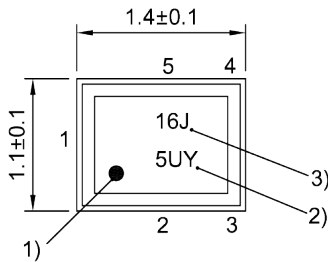
4 Pin configuration

- 1 Input
- 4 Output
- 2, 3, 5 Ground

SIDE VIEW

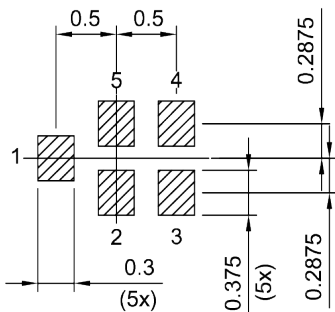


TOP VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

Land pattern  
THRU VIEW



Landing pad tolerance -0.02

**Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 16).

5 Matching circuit

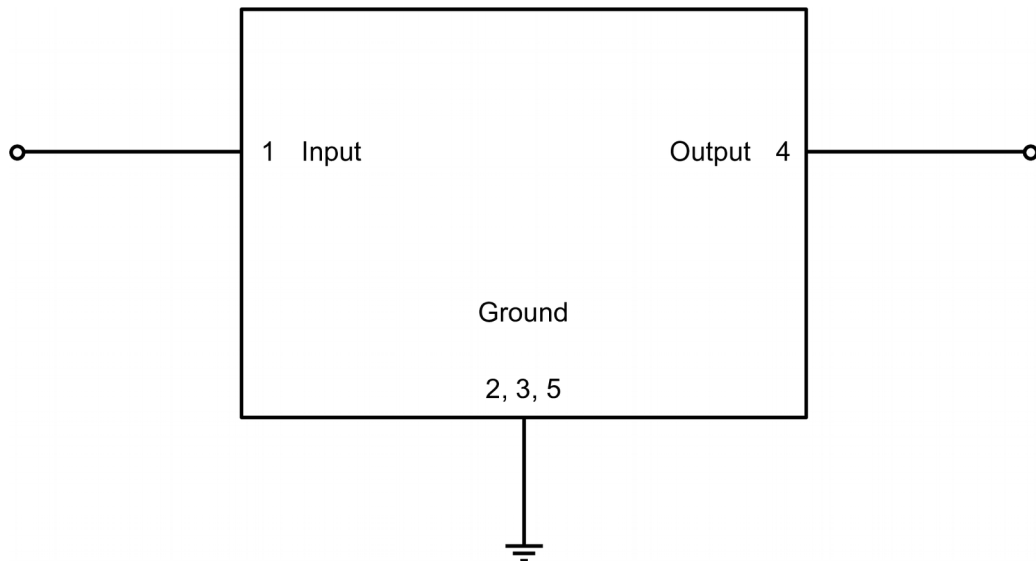


Figure 3: Schematic of matching circuit. No external matching components required.



## 6 Characteristics

Temperature range for specification	$T_{SPEC}$	= -40 °C ... +85 °C
Input terminating impedance	$Z_{IN}$	= 50 $\Omega$
Output terminating impedance	$Z_{OUT}$	= 50 $\Omega$

Characteristics		min. for $T_{SPEC}$	typ. @ +25 °C	max. for $T_{SPEC}$	
<b>Center frequency</b>	$f_C$	—	1575.42	—	MHz
<b>Maximum insertion attenuation</b>	$\alpha_{max}$				
	1572.42... 1578.42 MHz	—	1.2	1.8	dB
	1573.92... 1576.92 MHz	—	1.0	1.3	dB
<b>Amplitude ripple (p-p)</b>	$\Delta\alpha$				
	1572.42... 1578.42 MHz	—	0.4	1.0	dB
	1573.92... 1576.92 MHz	—	0.1	0.6	dB
<b>Maximum VSWR</b>	VSWR <sub>max</sub>				
@ input port	1572.42... 1578.42 MHz	—	1.5	1.9	
	1573.92... 1576.92 MHz	—	1.3	1.7	
@ output port	1572.42... 1578.42 MHz	—	1.5	1.9	
	1573.92... 1576.92 MHz	—	1.3	1.7	
<b>Minimum attenuation</b>	$\alpha_{min}$				
	1.0... 810 MHz	41	45	—	dB
	810... 1453 MHz	40	45	—	dB
	1453... 1525 MHz	37	44	—	dB
	1625... 1710 MHz	40	50	—	dB
	1710... 1749 MHz	43	50	—	dB
	1749... 1785 MHz	44	50	—	dB
	1785... 1920 MHz	43	50	—	dB
	1920... 2200 MHz	41	52	—	dB
	2200... 2450 MHz	35	40	—	dB
	2450... 2700 MHz	40	50	—	dB
	2700... 4000 MHz	30	35	—	dB

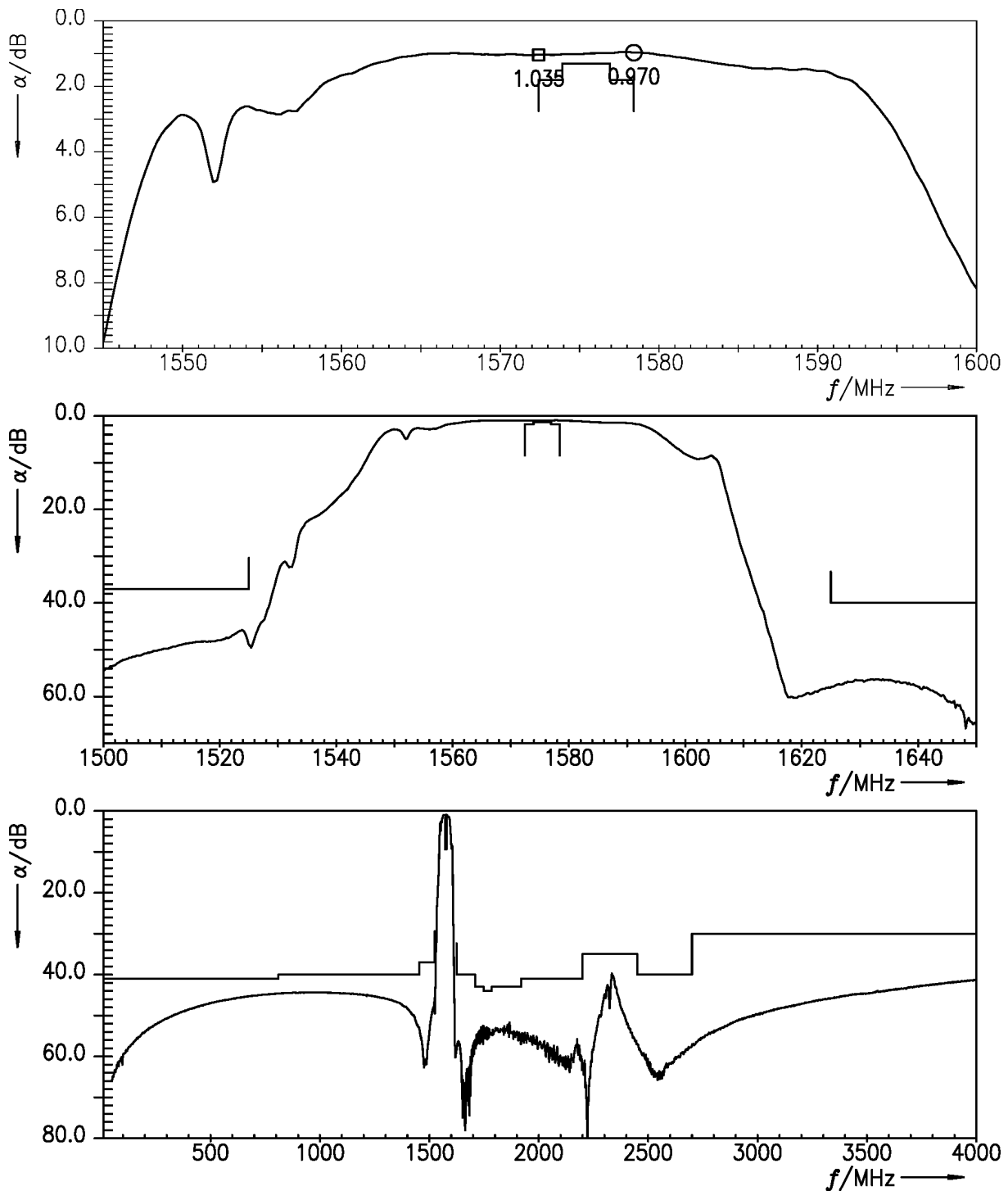
## 7 Maximum ratings

Operable temperature	$T_{OP} = -40\text{ °C} \dots +85\text{ °C}$	
Storage temperature	$T_{STG}^{1)} = -40\text{ °C} \dots +85\text{ °C}$	
DC voltage	$ V_{DC} ^{2)} = 0\text{ V (max.)}$	
Source power	$P_S$	
	10 dBm	Source impedance 50 Ω.
824 ... 915 MHz	20 dBm	
1710 ... 1785 MHz	20 dBm	

<sup>1)</sup> Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.

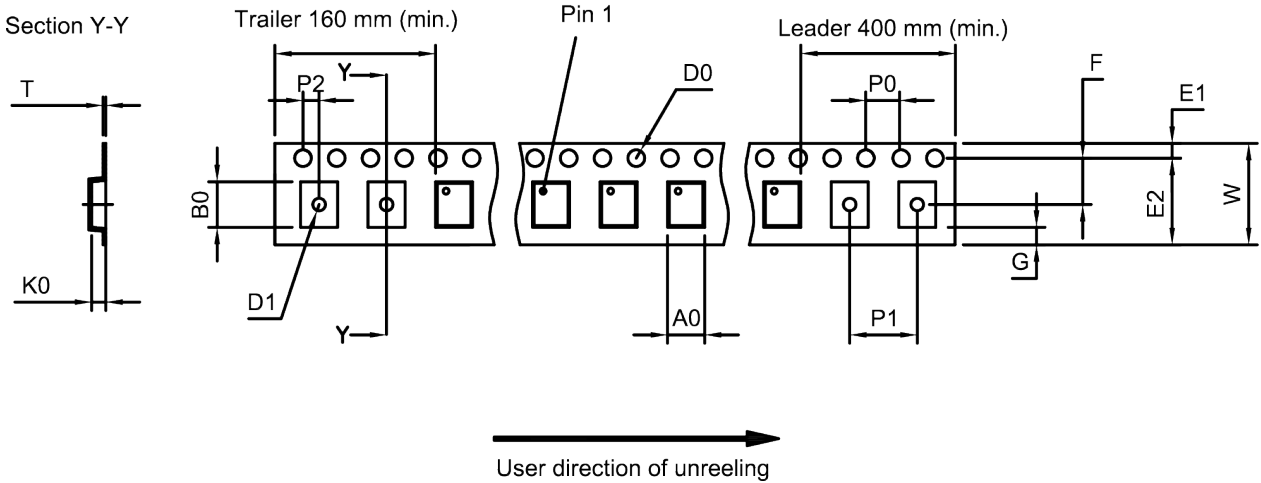
**8 Transmission coefficient**



**Figure 4:** Attenuation.

9 Packing material

9.1 Tape



**Figure 5:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A <sub>0</sub>	1.27±0.05 mm	E <sub>2</sub>	6.25 mm (min.)	P <sub>1</sub>	4.0±0.1 mm
B <sub>0</sub>	1.57±0.05 mm	F	3.5±0.05 mm	P <sub>2</sub>	2.0±0.05 mm
D <sub>0</sub>	1.5+0.1/-0 mm	G	0.75 mm (min.)	T	0.25±0.03 mm
D <sub>1</sub>	0.5±0.1 mm	K <sub>0</sub>	0.62±0.05 mm	W	8.0+0.3/-0.1 mm
E <sub>1</sub>	1.75±0.1 mm	P <sub>0</sub>	4.0±0.1 mm		

**Table 1:** Tape dimensions.

9.2 Reel with diameter of 180 mm

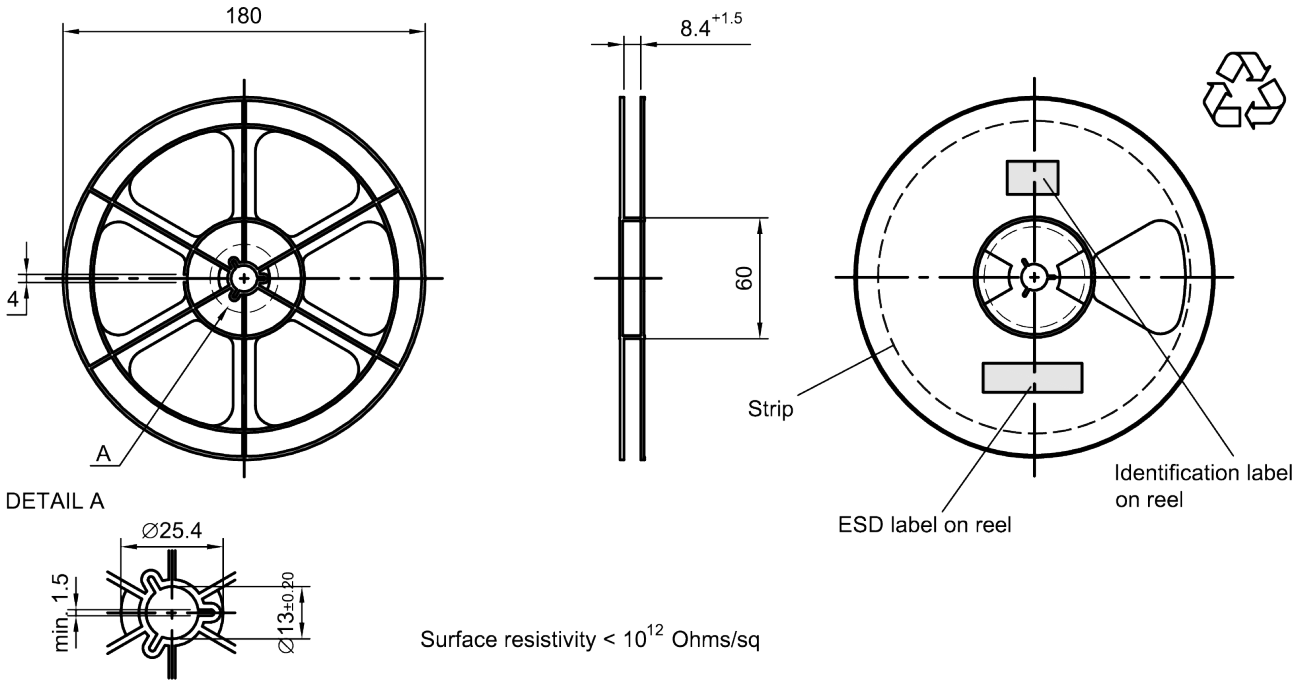


Figure 6: Drawing of reel (first-angle projection) with diameter of 180 mm.

Dimensions [mm]

X = 220+5

Y = 235+5

Sealing area 10±3

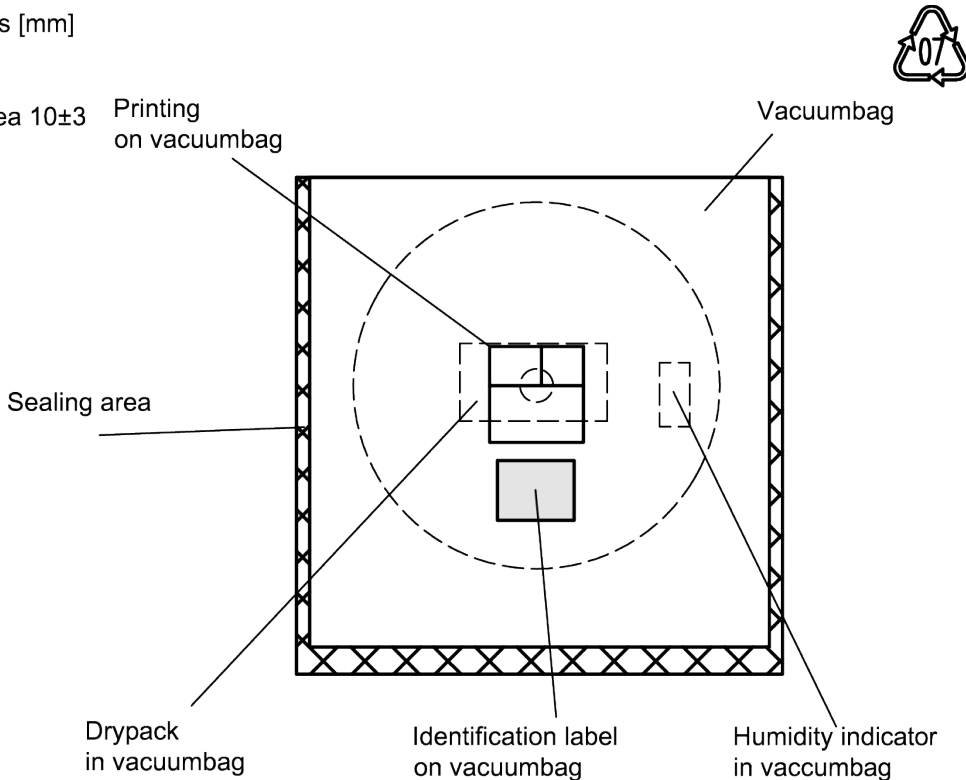
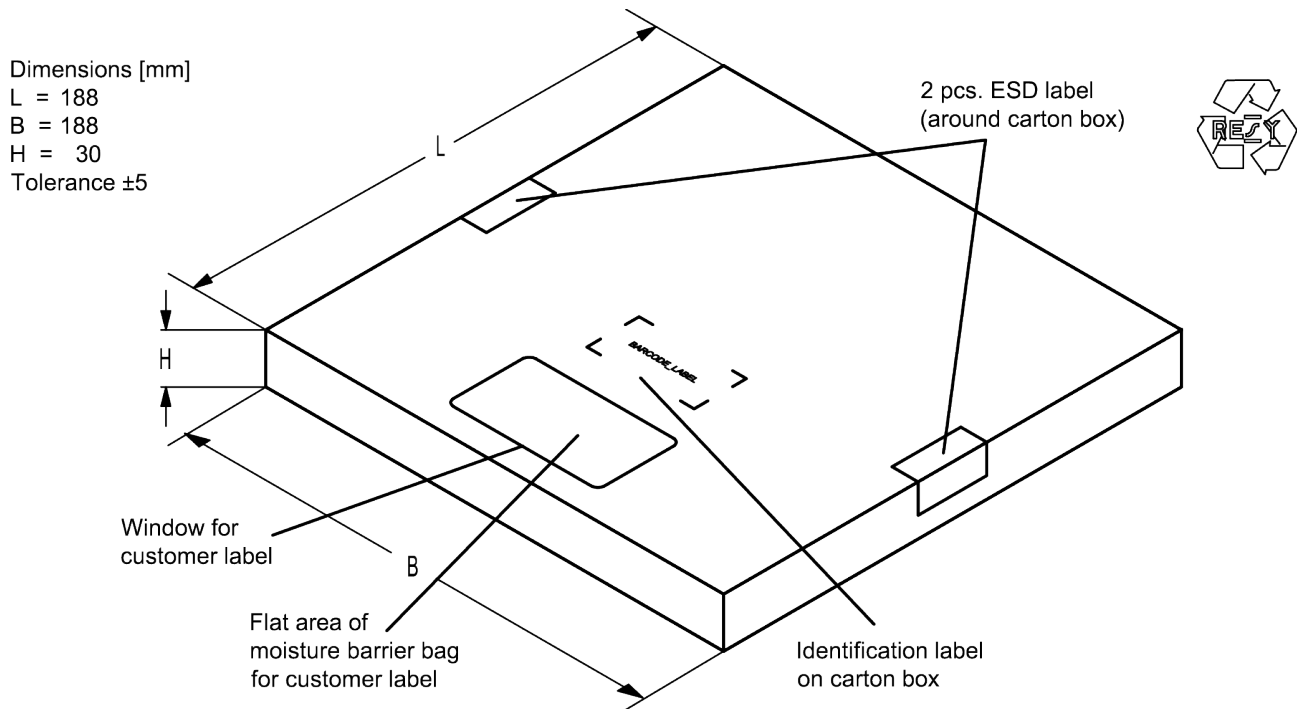


Figure 7: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.



**Figure 8:** Drawing of folding box for reel with diameter of 180 mm.

## 10 Marking

Products are marked with product type number and lot number encoded according to Table 2:

### ■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx,  
is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.  
**16J** => **1234**  
 $1 \times 32^2 + 6 \times 32^1 + 18 (=J) \times 32^0 =$  **1234**  
 The BASE32 code for product type B4300 is 46C.

### ■ Lot number:

The last 5 digits of the lot number, e.g., **12345**,  
are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.  
**5UY** => **12345**  
 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$  **12345**

Adopted BASE32 code for type number			
Decimal value	Base32 code	Decimal value	Base32 code
0	0	16	G
1	1	17	H
2	2	18	J
3	3	19	K
4	4	20	M
5	5	21	N
6	6	22	P
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	T
11	B	27	V
12	C	28	W
13	D	29	X
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	T
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	B	35	f
12	C	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	H	41	\
18	J	42	?
19	K	43	{
20	L	44	}
21	M	45	<
22	N	46	>
23	P		

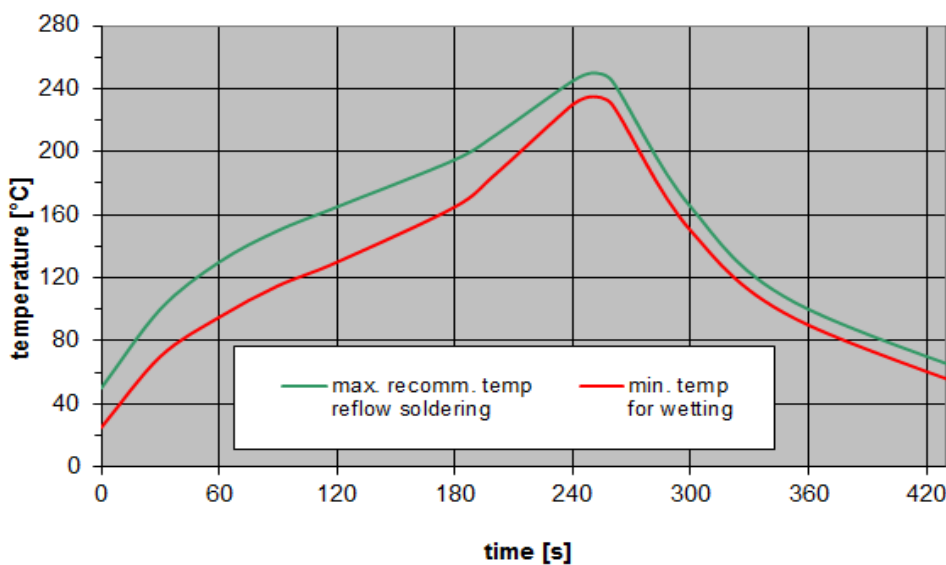
**Table 2:** Lists for encoding and decoding of marking.

## 11 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
T ≥ 255 °C	–
peak temperature $T_{peak}$	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

**Table 3:** Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 9:** Recommended reflow profile for convection and infrared soldering – lead-free solder.



## 12 Annotations

### 12.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

### 12.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

## 13 Cautions and warnings

### 13.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under [www.rf360jv.com/orderingcodes](http://www.rf360jv.com/orderingcodes).

### 13.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

### 13.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

### 13.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

#### Projection method

Unless otherwise specified first-angle projection is applied.

## 14 Important notes

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